

DMN65D8LW

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	Package	Ι _D T _A = +25°C	
60)/	3Ω @ V _{GS} = 10V 3		300mA	
60V	$4\Omega @ V_{GS} = 5V$	501323	260mA	

Description

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **DC-DC Converters**
- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc



ESD PROTECTED ŤO 1kV

SOT323

Top View



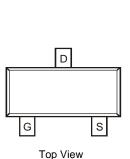
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate, 1KV (HBM)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

N-CHANNEL ENHANCEMENT MODE MOSFET

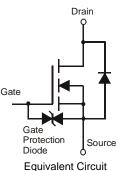
Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)



Pin Configuration



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN65D8LW-7	SOT323	3000/Tape & Reel

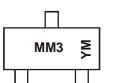
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com

Marking Information



MM3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)

M = Month (ex: 9 = September)

Notes:

Date Obuc Rey												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
			+									
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	300 230	mA
Continuous Drain Current (Note 6) $V_{GS} = 5V$	ID	260 210	mA		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	800	mA		
Maximum Body Diode Continuous Current (Note 6)	Is	1	А		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation	(Note 5)	D	300	mW	
	(Note 6)	PD	432		
Thermal Desistance Junction to Ambient	(Note 5)	6	398		
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{ heta JA}$	290	°C/W	
Thermal Resistance, Junction to Case	(Note 5)	R _{θJC}	142		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

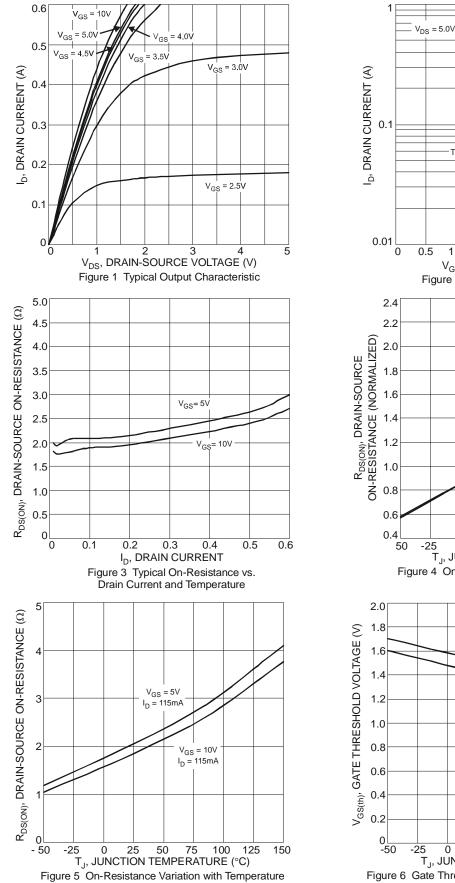
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}		_	1.0	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage	Igss		_	±5.0	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						-
Gate Threshold Voltage	V _{GS(th)}	1.2	_	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance		—	2	3	Ω	$V_{GS} = 10V, I_D = 0.115A$
	R _{DS (ON)}		2.5	4	Ω	$V_{GS} = 5V, I_D = 0.115A$
Forward Transconductance	g fs	80	290	_	mS	V _{DS} = 10V, I _D = 0.115A
Diode Forward Voltage	V _{SD}	-	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	22.0	_		V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	Coss		3.2	_	pF	
Reverse Transfer Capacitance	C _{rss}		2.0	_		
Gate Resistance	R _G		79.9	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge V _{GS} = 10V	Qg	_	0.87	_		
Total Gate Charge V _{GS} = 4.5V	Qq		0.43	_	nC	$V_{GS} = 10V, V_{DS} = 30V,$
Gate-Source Charge	Q _{gs}		0.11	—	nC	I _D = 150mA
Gate-Drain Charge	Q _{qd}		0.11	_		
Turn-On Delay Time	t _{D(on)}	—	2.7	—		
Turn-On Rise Time	tr		2.8	—	nS	V _{DD} = 30V, I _D = 0.115A, V _{GEN} = 10V,
Turn-Off Delay Time	t _{D(off)}	—	12.6	—	ns	$R_{GEN} = 25\Omega$
Turn-Off Fall Time	t _f	—	7.3	—	1	

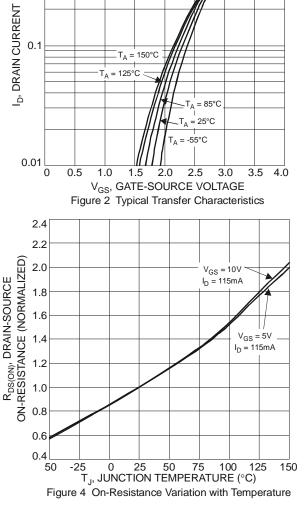
Notes:

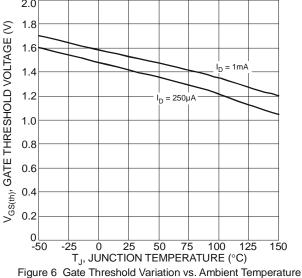
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.



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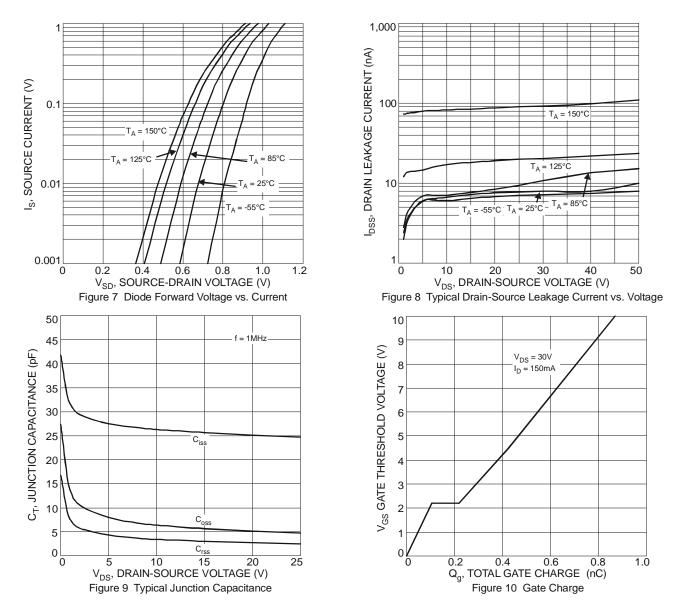






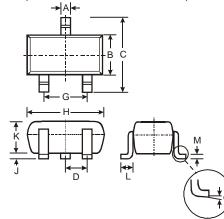


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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

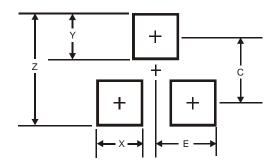


	SOT323						
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
Н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
К	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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Website :

Welcome to visit www.ameya360.com

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

- > Sales :
 - Direct +86 (21) 6401-6692
 - Email amall@ameya360.com
 - QQ 800077892
 - Skype ameyasales1 ameyasales2

> Customer Service :

Email service@ameya360.com

> Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com